**SPDT UltraCMOS™
10 MHz - 3 GHz RF Switch**

## Product Description

*The PE4242 UltraCMOS™ RF Switch is designed to cover a broad range of applications from 10 MHz through 3 GHz. This reflective switch integrates on-board CMOS control logic with a low voltage CMOS-compatible control interface, and can be controlled using either single-pin or complementary control inputs. Using a nominal +3-volt power supply voltage, a typical input 1 dB compression point of +27 dBm can be achieved.*

*The PE4242 RF Switch is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.*
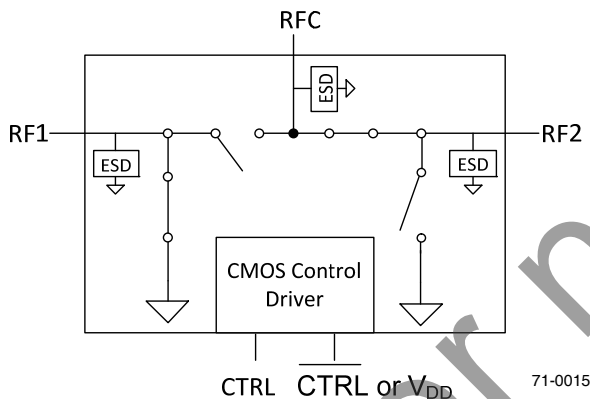
### Features

- Single-pin or complementary CMOS logic control inputs

- +3.0-volt power supply needed for single-pin control mode

- Low insertion loss: 0.7 dB at 1000 MHz, 0.9 dB at 2000 MHz

- Isolation of 32 dB at 1000 MHz, 23 dB at 2000 MHz

- Typical input 1 dB compression point of +27 dBm

- Ultra-small SC-70 package

**Figure 1. Functional Diagram**



71-0015

**Figure 2. Package Type**

6-lead SC-70



## Table 1. Electrical Specifications @ +25 °C, $V_{DD}$ = 3 V ($Z_S$ = $Z_L$ = 50 Ω)

| Parameter | Conditions | Minimum | Typical | Maximum | Units |
|---|---|---|---|---|---|
| Operation Frequency[1] | | 10 | | 3000 | MHz |
| Insertion Loss | 1000 MHz<br>2000 MHz | | 0.7<br>0.9 | 0.85<br>1.05 | dB<br>dB |
| Isolation | 1000 MHz<br>2000 MHz | 30<br>21 | 32<br>23 | | dB<br>dB |
| Return Loss | 1000 MHz<br>2000 MHz | 18<br>16 | 22<br>18 | | dB<br>dB |
| 'ON' Switching Time | 50% CTRL to 0.1 dB of final value, 1 GHz | | 300 | | ns |
| 'OFF' Switching Time | 50% CTRL to 25 dB isolation, 1 GHz | | 200 | | ns |
| Video Feedthrough[2] | | | 15 | | mV$_{pp}$ |
| Input 1 dB Compression | 2000 MHz | 26 | 27 | | dBm |
| Input IP3 | 2000 MHz, 14 dBm input power | 43 | 45 | | dBm |

Notes: 1. Device linearity will begin to degrade below 10 MHz
2. The DC transient at the output of any port of the switch when the control voltage is switched from Low to High or High to Low in a 50 Ω test set-up, measured with 1ns risetime pulses and 500 MHz bandwidth.
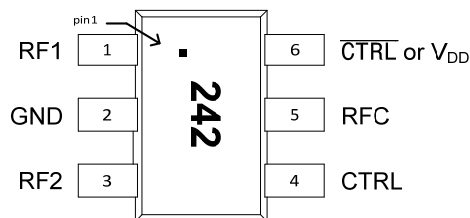
## Figure 3. Pin Configuration (Top View)



## Table 2. Pin Descriptions[1]

| Pin No. | Pin Name | Description |
|---------|----------|-------------|
| 1 | RF1 | RF1 port[2] |
| 2 | GND | Ground connection. Traces should be physically short and connected to ground plane for best performance. |
| 3 | RF2 | RF2 port[1] |
| 4 | CTRL | Switch control input, CMOS logic level |
| 5 | RFC | Common RF port for switch[1] |
| 6 | $\overline{\text{CTRL}}$ or $V_{DD}$ | This pin supports two interface options: *Single-pin control mode.* A nominal 3-volt supply connection is required. *Complementary-pin control mode.* A complementary CMOS control signal to CTRL is supplied to this pin. Bypassing on this pin is not required in this mode. |

Note: 1. Operation should be restricted to the limits in the Operating Ranges table.
2. All RF pins must be DC blocked with an external series capacitor or held at 0 $V_{DC}$.

## Table 3. Absolute Maximum Ratings

| Symbol | Parameter/Conditions | Min | Max | Units |
|--------|---------------------|-----|-----|-------|
| $V_{DD}$ | Power supply voltage | -0.3 | 4.0 | V |
| $V_I$ | Voltage on any input | -0.3 | $V_{DD}$+ 0.3 | V |
| $T_{ST}$ | Storage temperature range | -65 | 150 | °C |
| $T_{OP}$ | Operating temperature range | -40 | 85 | °C |
| $P_{IN}$ | Input power (50 Ω) | | 30 | dBm |
| $V_{ESD}$[1] | HBM ESD Voltage | | 1500 | V |

Note: 1. Human Body Model ESD Voltage (HBM, MIL_STD 883 Method 3015.7)

Exceeding absolute maximum ratings may cause permanent damage. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

## Table 4. DC Electrical Specifications

| Parameter | Min | Typ | Max | Units |
|-----------|-----|-----|-----|-------|
| $V_{DD}$ Power Supply Voltage | 2.7 | 3.0 | 3.3 | V |
| $I_{DD}$ Power Supply Current ($V_{DD}$ = 3 V, $V_{CTRL}$ = 3 V) | | 250 | 500 | nA |
| Control Voltage High | 0.7x $V_{DD}$ | | | V |
| Control Voltage Low | | | 0.3x $V_{DD}$ | V |

## Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

## Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

## Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE4242 in the 6-lead SC-70 package is MSL1.

## Table 5. Single-pin Control Logic Truth Table

| Control Voltages | Signal Path |
|---|---|
| Pin 6 ($V_{DD}$) = $V_{DD}$<br>Pin 4 (CTRL) = Low | RFC to RF1 |
| Pin 6 ($V_{DD}$) = $V_{DD}$<br>Pin 4 (CTRL) = High | RFC to RF2 |

## Table 6. Complementary-pin Control Logic Truth Table

| Control Voltages | Signal Path |
|---|---|
| Pin 6 ($\overline{CTRL}$ or $V_{DD}$) = High<br>Pin 4 (CTRL) = Low | RFC to RF1 |
| Pin 6 ($\overline{CTRL}$ or $V_{DD}$) = Low<br>Pin 4 (CTRL) = High | RFC to RF2 |

## Control Logic Input

The PE4242 is a versatile RF CMOS switch that supports two operating control modes; single-pin control mode and complementary-pin control mode.

*Single-pin control mode* enables the switch to operate with a single control pin (pin 4) supporting a +3-volt CMOS logic input, and requires a dedicated +3-volt power supply connection on pin 6 ($V_{DD}$). This mode of operation reduces the number of control lines required and simplifies the switch control interface typically derived from a CMOS µProcessor I/O port.

*Complementary-pin control mode* allows the switch to operate using complementary control pins CTRL and $\overline{CTRL}$ (pins 4 & 6), that can be directly driven by +3-volt CMOS logic or a suitable µProcessor I/O port. This enables the PE4242 to be used as a potential alternate source for SPDT RF switch products used in positive control voltage mode and operating within the PE4242 operating limits.

## Evaluation Kit

The SPDT Switch Evaluation Kit board was designed to ease customer evaluation of the PE4242 SPDT switch. The RF common port is connected through a 50 Ω transmission line to the top left SMA connector, J1. Port 1 and Port 2 are connected through 50 Ω transmission lines to the top two SMA connectors on the right side of the board, J3 and J2, respectively. A through transmission line connects SMA connectors J4 and J5. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a two metal layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.0476", trace gaps of 0.030", dielectric thickness of 0.028", metal thickness of 0.0021" and $\varepsilon_r$ of 4.4.

J6 provides a means for controlling DC and digital inputs to the device. Starting from the lower left pin, the second pin to the right (J6-3) is connected to the device V1 or CTRL input. The fourth pin to the right (J6-7) is connected to the device V2 or $\overline{\text{CTRL}}/V_{DD}$ input.

**Figure 4. Evaluation Board Layout**
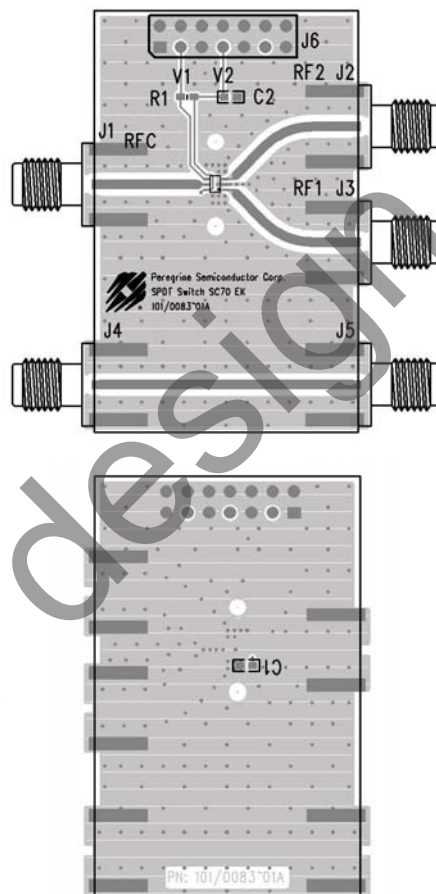


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**Figure 5. Evaluation Board Schematic**



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Document No. 70-0095-04 │ UltraCMOS™ RFIC Solutions

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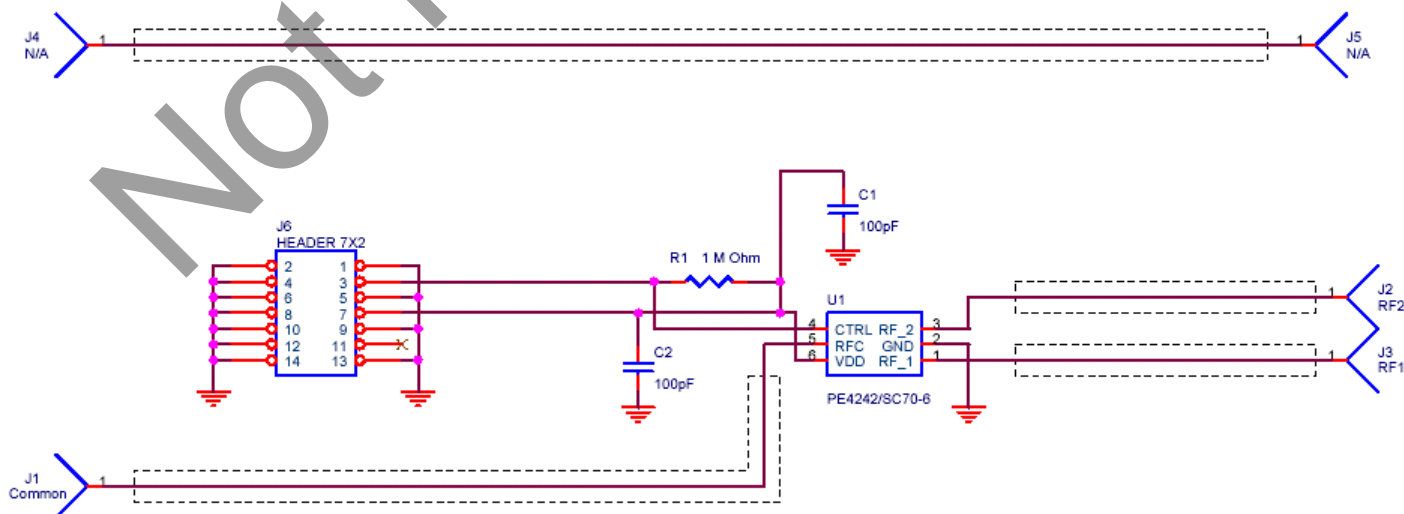
## Typical Performance Data @ -40 °C to 85 °C (Unless otherwise noted)

### Figure 6. Insertion Loss – RFC to RF1
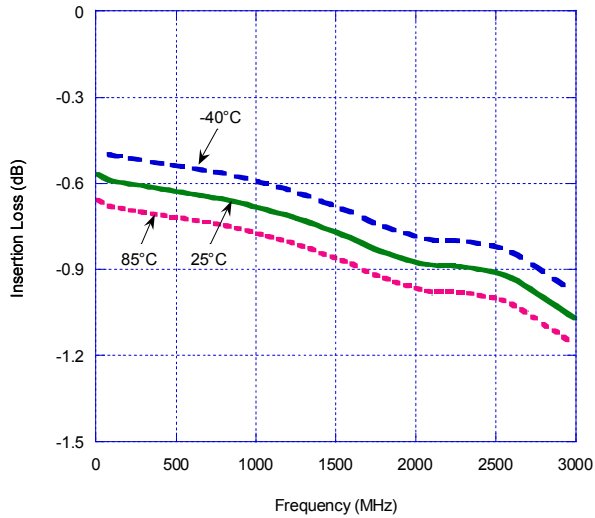


### Figure 7. Input 1 dB Compression Point & IIP3
### (Typical Performance @ 25 °C)
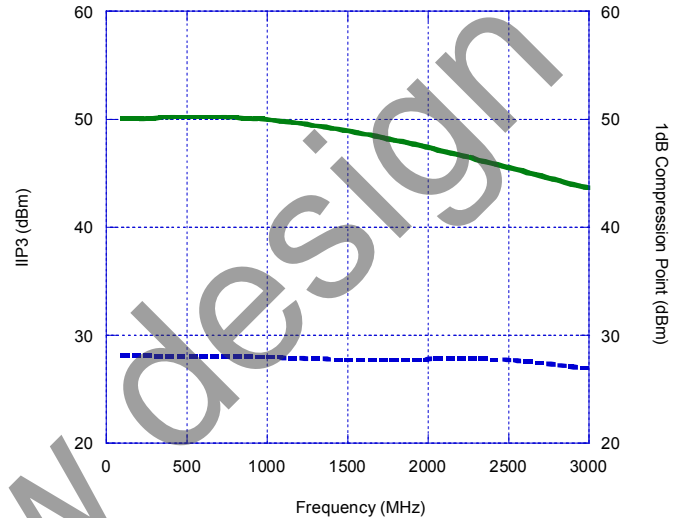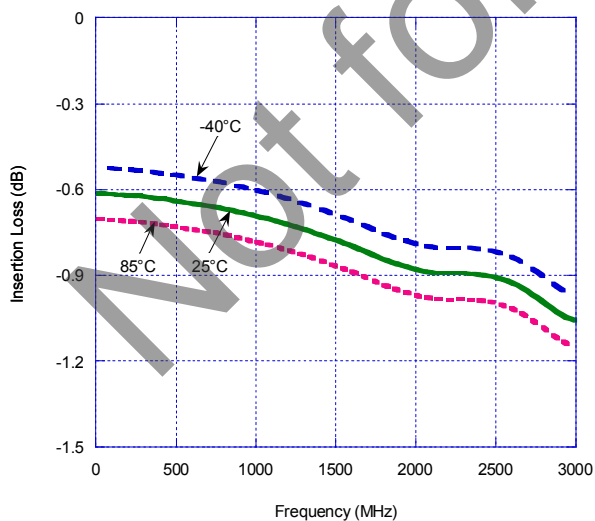


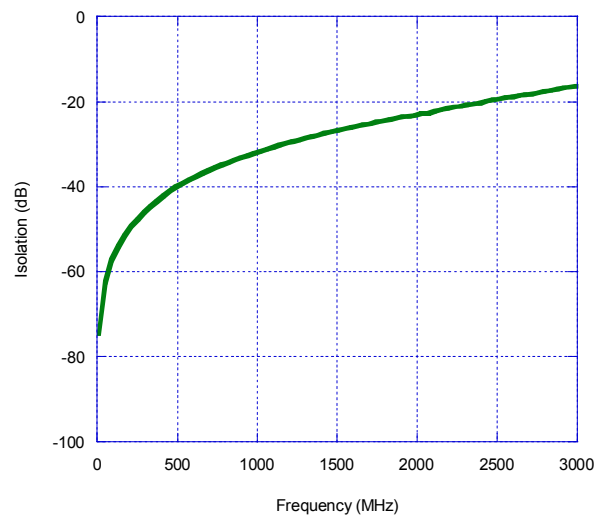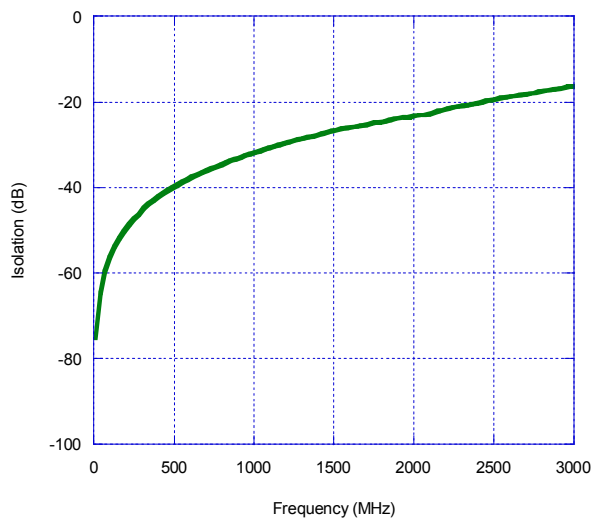### Figure 8. Insertion Loss – RFC to RF2



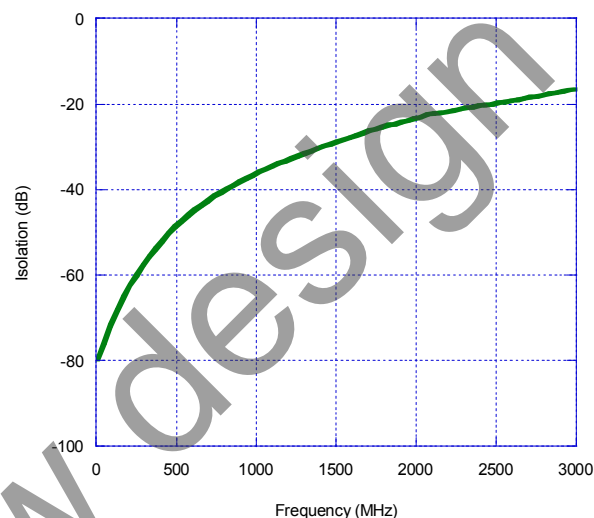### Figure 9. Isolation – RFC to RF1
### (Typical Performance @ 25 °C)

## Typical Performance Data @ 25°C

**Figure 10. Isolation – RFC to RF2**



**Figure 11. Isolation – RF1 to RF2, RF2 to RF1**



**Figure 12. Return Loss – RFC to RF1, RF2**
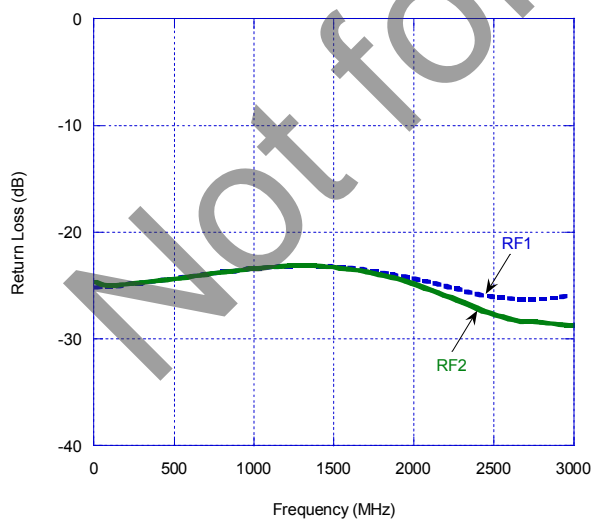


**Figure 13. Return Loss – RF1, RF2**

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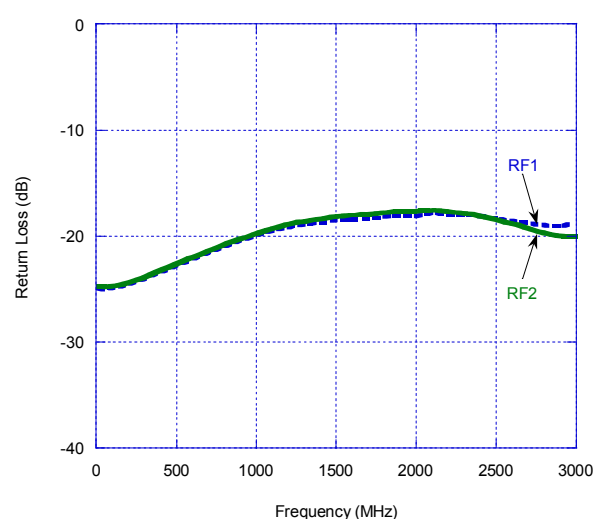
## Figure 14. Package Drawing

6-lead SC-70
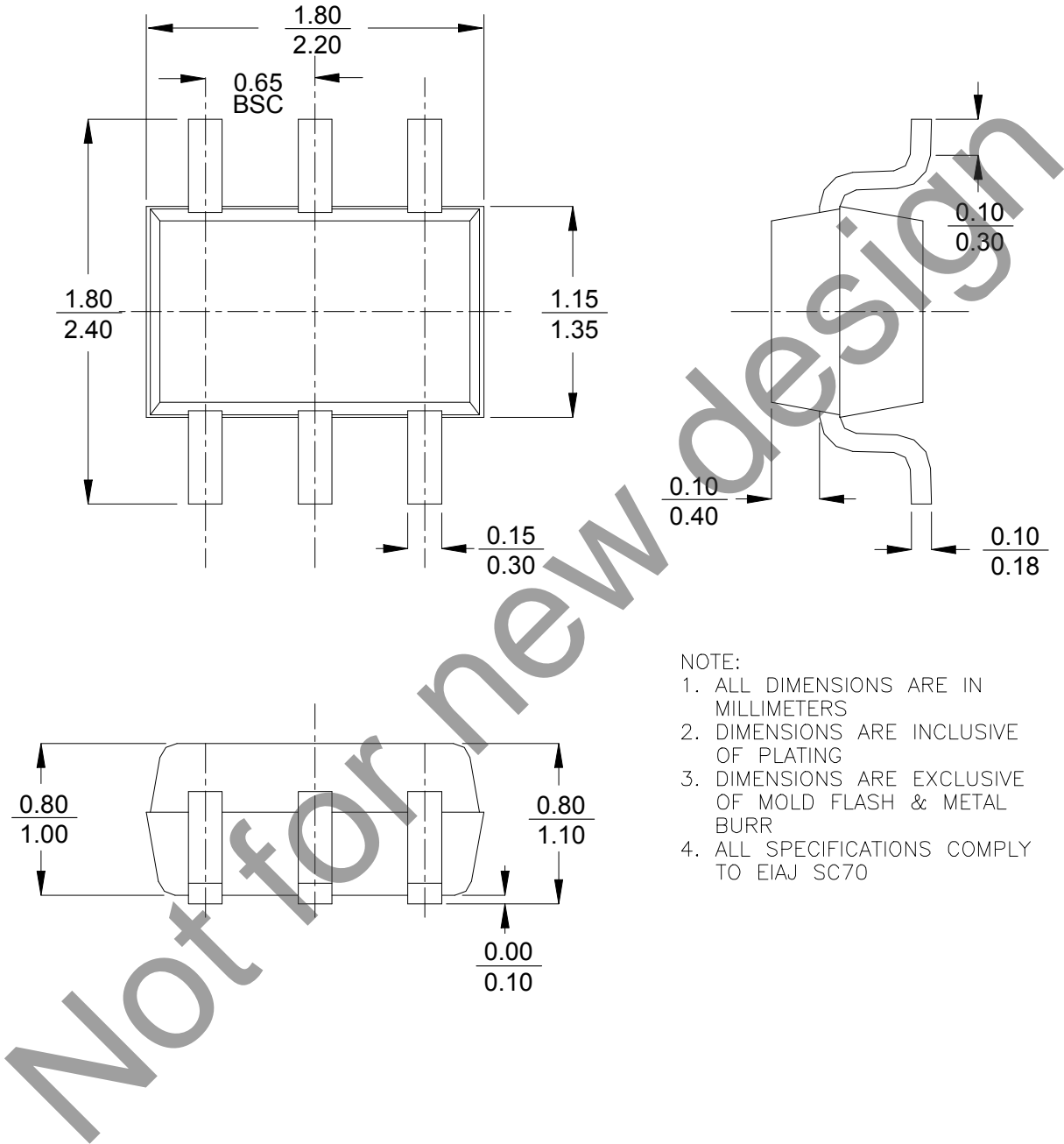


NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS ARE INCLUSIVE OF PLATING
3. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH & METAL BURR
4. ALL SPECIFICATIONS COMPLY TO EIAJ SC70

## Figure 15. Tape and Reel Specifications



Tape Feed Direction
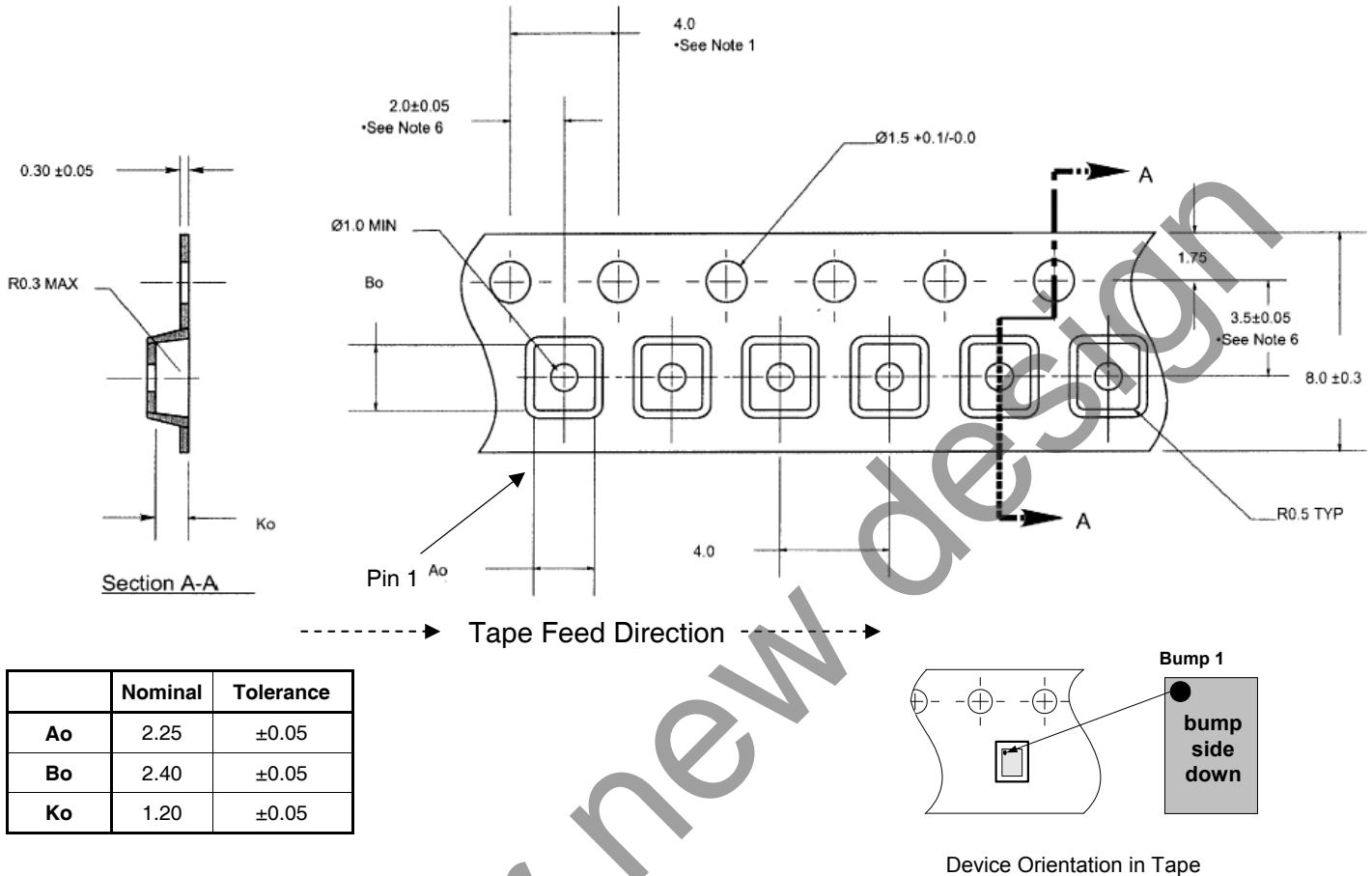
|     | Nominal | Tolerance |
|-----|---------|-----------|
| Ao  | 2.25    | ±0.05     |
| Bo  | 2.40    | ±0.05     |
| Ko  | 1.20    | ±0.05     |

Device Orientation in Tape

Notes: 10 sprocket hole pitch cumulative tolerance ±0.02
Camber not to exceed 1 mm in 100 mm
Material: Black Conductive Advantek Polystyrene
Ao and Bo measured on a plane 0.3 mm above the bottom of the pocket
Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier
Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole

## Table 7. Ordering Information

| Order Code | Part Marking | Description | Package | Shipping Method |
|------------|--------------|-------------|---------|-----------------|
| 4242-00 | PE4242-EK | PE4242-06SC70-EK | Evaluation Kit | 1 / Box |
| 4242-52 | 242 | PE4242G-06SC70-3000C | Green 6-lead SC-70 | 3000 units / T&R |

## Sales Contact and Information

For Sales and contact information please visit www.psemi.com.